

AF JFW



[10191/1629]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : LAERMER et al. Confirmation No.: 5642  
Serial No. : 09/720,761  
Filed : March 26, 2001  
For : METHOD OF PLASMA ETCHING OF SILICON  
Examiner : K. Chen  
Art Unit : 1765  
Customer No. : 26646

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Date 5/22/06 Atty's Reg. # 41,172  
Atty's Signature LDZ  
**DERVIS MAGISTRE**  
**KENYON & KENYON LLP**

AMENDMENT TRANSMITTAL

SIR:

Please find an Amendment transmitted herewith for filing in the above-identified patent application.

No fee is believed to be required. However, if any fee is required, please use Deposit Account No. 11-0600. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,

KENYON & KENYON LLP

By: LDZ  
(Reg. No. 41,172)

Dated: 5/22/06

By: GCZ  
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**AMENDMENT**

SIR:

In response to the Office Action dated February 22, 2006, please amend the above-identified application as set forth below.

**Amendments to the Specification** do not appear in this paper.

**Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.

**Amendments to the Drawings** do not appear in this paper

**Remarks** begin on page 6 of this paper.